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Date of Signature and Deposit: October 18, 2002 Alm T

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):

Mark A. Lucak, et al. '

Serial No.:

09/843,563

Filed:

April 26, 2001

For:

Method for Fabricating a Microelectromechanical System

(MEMS) Device Using a Pre-Patterned Substrate

Group Art Unit:

2812

Docket No.:

110003.97427

PRELIMINARY AMENDMENT

Commissioner for Patents Washington DC 20231

Dear Sir:

Prior to the substantive examination of the above-captioned application, please amend the application as follows.

IN THE CLAIMS:

10/31/2002 JHCHILLA 00000001 170055 09843563

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144.00 CHThe following amended claims should be replaced for like numbered claims originally filed in the pending patent application, and the new claims should be added to the application. A version of the new and amended claims with markings to show changes made is attached to the end of this communication.

New Claims

- 1. (Once Amended) A method of fabricating a MEMS structure, comprising the steps of:
 - (a) forming a recess in an upper surface of a substrate;

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